SKIIP 12AC12T4V1



MiniSKiiP[®] 1

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Features*

- Trench 4 IGBTs
- · Robust and soft switching freewheeling diodes in CAL technology
- · Highly reliable spring contacts for
- electrical connections • UL recognized: File no. E63532

Typical Applications

- Inverter up to 12 kVA
- Typical motor power 5,5 kW

Remarks

- V_{CEsat}, V_F = chip level value
- Case temp. limited to $T_C = 125^{\circ}C$ max. (for baseplateless modules $T_C = T_S$)
- product rel. results valid for $T_i \le 150$ (recomm. $T_{op} = -40 \dots + 150^{\circ}C$)

ICES

Cies

 C_{oes}

Cres

 Q_{G}

R_{Gint}

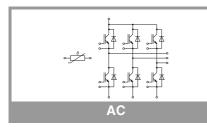
t_{d(on)}

tr

t_f

Eoff

Eon



Absolute	Maximum Rating	S					
Symbol	Conditions		Values				
Inverter -	IGBT						
V _{CES}	T _j = 25 °C			1200		V	
Ic	λ _{paste} =0.8 W/(mK)	T _s = 25 °C		18			
	T _j = 175 °C	T _s = 70 °C		18			
I _C	$\lambda_{\text{paste}}=2.5 \text{ W/(mK)}$	T _s = 25 °C		31			
	T _j = 175 °C	T _s = 70 °C		26			
I _{Cnom}				15			
I _{CRM}				45		Α	
V_{GES}				-20 20		V	
t _{psc}	$V_{CC} = 800 V$ $V_{GE} \le 15 V$ $V_{CES} \le 1200 V$	T _j = 150 °C		10			
Tj				-40 175			
Inverse -	Diode					-	
V _{RRM}	T _j = 25 °C			1200		V	
I _F	λ _{paste} =0.8 W/(mK)	T _s = 25 °C		23			
T _j = 175 °C	T _j = 175 °C	T _s = 70 °C		18			
I _F	λ _{paste} =2.5 W/(mK)	T _s = 25 °C		25			
	T _j = 175 °C	T _s = 70 °C		20			
I _{FRM}				45			
I _{FSM}	t _p = 10 ms, sin 180°, T _j = 150 °C			65			
Tj			-40 175				
Module							
I _{t(RMS)}	T _{terminal} = 80 °C, 20	A per spring		20		Α	
T _{stg}	module without TIM -40 125			°C			
V _{isol}	AC sinus 50 Hz, t =	= 1 min		2500			
Characte	vistios						
	1			t 1 (m)	-	1.1	
Symbol	Conditions		min.	typ.	max.	Unit	
Inverter -	$I_{C} = 15 \text{ A}$			4.05	0.40		
V _{CE(sat)}	$V_{GE} = 15 \text{ V}$	T _j = 25 °C		1.85	2.10	V	
	chiplevel	T _j = 150 °C		2.25	2.45	V	
V _{CE0}	chiplevel	T _j = 25 °C		0.80	0.90	V	
		T _j = 150 °C		0.70	0.80	V	
r _{CE}	V _{GE} = 15 V	T _j = 25 °C		70	80	mΩ	
	chiplevel	T _j = 150 °C		103	110	mΩ	
$V_{\text{GE(th)}}$	$V_{GE} = V_{CE}, I_C = 1 \text{ m}$	nA	5	5.8	6.5	V	
			1			1	

 $V_{GE} = 0 V, V_{CE} = 1200 V, T_i = 25 °C$

 $V_{CE} = 25 V$

 $V_{GE} = 0 V$

T_i = 25 °C

 $I_{\rm C} = 15 \, {\rm A}$

 $V_{CC} = 600 V$

 $R_{G on} = 39 \Omega$

 $R_{G off} = 39 \ \Omega$

V_{GE} = - 8 V...+ 15 V

f = 1 MHz

f = 1 MHz

f = 1 MHz

T_i = 150 °C

T_i = 150 °C

T_i = 150 °C

mA

nF

nF

nF

nC

Ω

ns

ns

mJ

ns

ns

mJ

K/W

K/W

1

0.90

0.08

0.06

85

0

31

30

1.65



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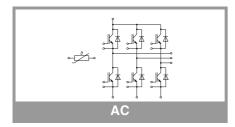
Typical Applications

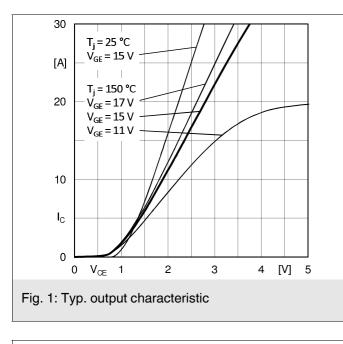
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- Typical motor power 5,5 kW

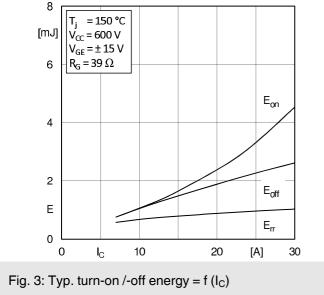
Remarks

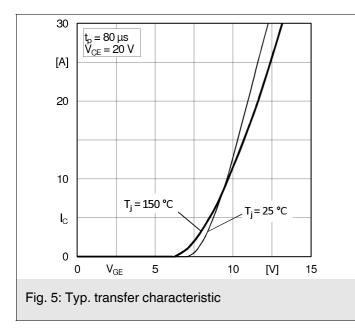
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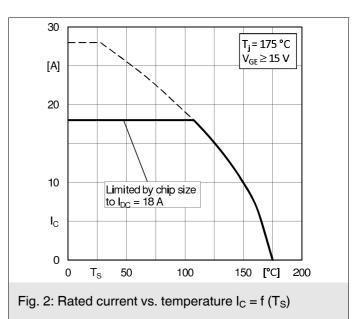
Characte	ristics					
Symbol	Conditions		min.	typ.	max.	Unit
Inverse -	Diode					
$V_F = V_{EC}$	I _F = 15 A	T _j = 25 °C		2.38	2.71	V
V _{GE} = 0 V chiplevel		T _j = 150 °C		2.44	2.77	V
V _{F0}	chiplevel	T _j = 25 °C		1.30	1.50	V
	chiplevel	T _j = 150 °C		0.90 1.10 72 81 103 111 12 2 0.79 1.92	V	
ŕ _F	chiplevel	T _j = 25 °C		72	81	mΩ
		T _j = 150 °C		103	111	mΩ
I _{RRM}	$I_{F} = 15 \text{ A}$ di/dt _{off} = 500 A/µs V _{GE} = +15/-15 V V _{CC} = 600 V	T _j = 150 °C		12		Α
Q _{rr}		T _j = 150 °C		2		μC
E _{rr}		T _j = 150 °C		0.79		mJ
R _{th(j-s)}	per Diode, $\lambda_{paste}=0.8$ W/(mK)			1.92		K/W
R _{th(j-s)}	per Diode, λ_{paste} =2.5 W/(mK)			1.65		K/W
Module						
L _{CE}				-		nH
Ms	to heat sink		2		2.5	Nm
w				30		g
Temperat	ure Sensor					
R ₁₀₀	T _r =100°C (R ₂₅ =1000Ω)			1670 ± 3%		Ω
R _(T)	$\begin{array}{l} {\sf R}_{(T)}{=}1000\Omega [1{+}{\sf A}(T\\ ,{\sf A}=7.635^{*}10^{-3\circ}{\rm C}^{-}\\ {\sf B}=1.731^{*}10^{-5\circ}{\rm C}^{-2} \end{array}$					

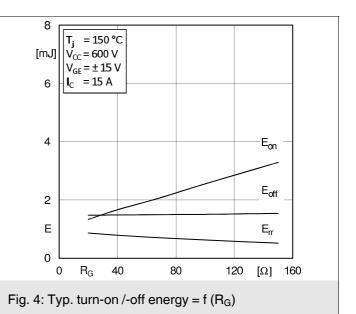


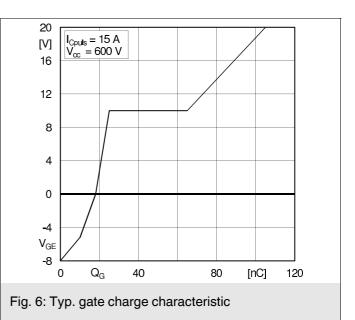


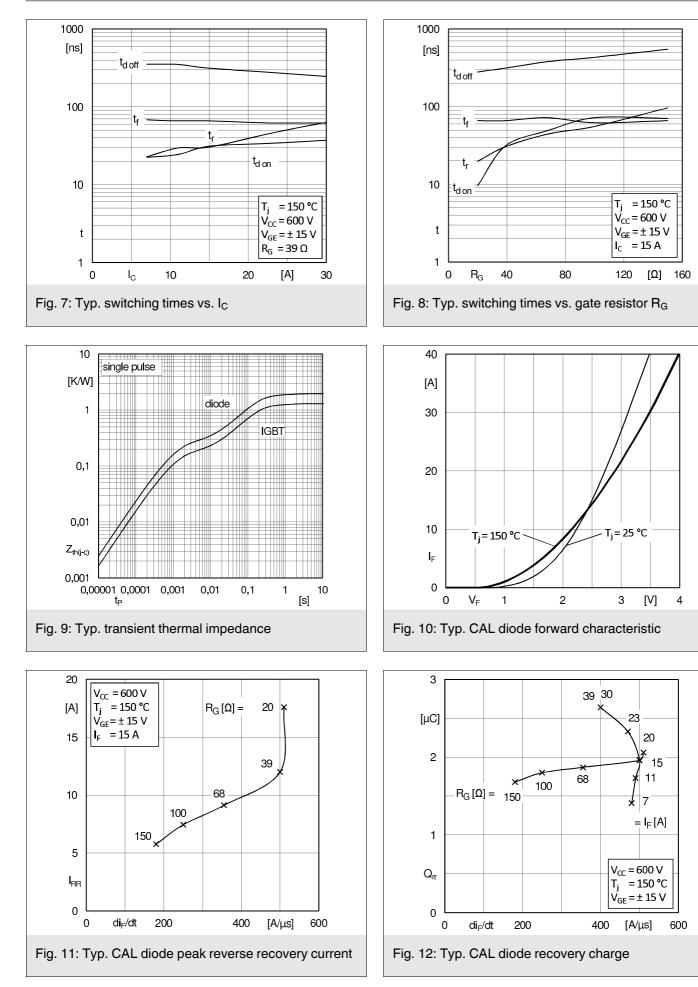






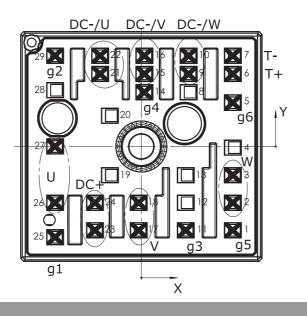




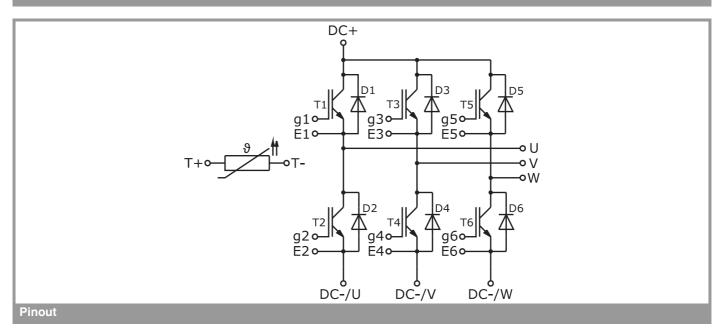


Pin out								
Pin	X	Y	Function	Pin	X	Y	Function	
1	15,93	-14,60	g5	16	0,53	15,80	DC-/V	
2	15,93	-9,80	W	17	-0,48	-14,6	V	
3	15,93	-5,00	W	18	-0,48	-9,80	V	
4	15,93	-0,20		19	-5,48	-5,00		
5	15,93	7,63	g6	20	-5,48	5,35		
6	15,93	12,63	T+	21	-7,18	12,63	DC-/U	
7	15,93	15,80	Т-	22	-7,18	15,80	DC-/U	
8	8,23	9,45		23	-8,08	-14,60	DC+	
9	8,23	12,63	DC-/W	24	-8,08	-9,80	DC+	
10	8,23	15,80	DC-/W	25	-15,03	-15,80	g1	
11	7,73	-14,60	g3	26	-15,03	-9,80	U	
12	7,73	-9,80		27	-15,03	0	U	
13	7,73	-5,00		28	-15,03	9,80		
14	0,53	9,45	g4	29	-15,03	15,80	g2	
15	0,53	12,63	DC-/V					

all values in mm



Pinout and Dimensions



This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

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